

Inference

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|--------|--|---|------------------|---------|------------------|
| L1 | 0 | ("packag\$3andbond\$3near2pad\$1andencapsulat\$3anddielectricandbumpandchipandtrace\$1and(cavityorholeorvia)").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | OFF | 2007/01/12 16:48 |
| L2 | 235826 | packag\$3 and bond\$3 near2pad\$1 and encapsulat\$3 and dielectric and bump and chip and trace\$1 and (cavity or hole or via) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | OFF | 2007/01/12 16:50 |
| L3 | 657 | packag\$3 and bond\$3 near2 pad\$1 and encapsulat\$3 and dielectric and bump and chip and trace\$1 and (cavity or hole or via) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | OFF | 2007/01/12 16:50 |

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|--|--------------------------|------------------|---------|------------------|
| L4 | 376 | packag\$3 and bond\$3 near2 pad\$1 and encapsulat\$3 and dielectric and bump and chip and trace\$1 and (cavity or hole or via) | USPAT; EPO; JPO; DERWENT | OR | OFF | 2007/01/12 16:50 |